

# N-channel 80 V 4.7 m $\Omega$ standard level MOSFET

Rev. 02 — 23 June 2009

**Product data sheet** 

## 1. Product profile

### 1.1 General description

Standard level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

### 1.2 Features and benefits

 High efficiency due to low switching and conduction losses

### **1.3 Applications**

- DC-to-DC converters
- Load switching

### 1.4 Quick reference data

 Suitable for standard level gate drive sources

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- Motor control
- Server power supplies

Table 1.	Quick reference						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{DS}$	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C		-	-	80	V
I <sub>D</sub>	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u>		-	-	100	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>		-	-	270	W
Dynamic	characteristics						
Q <sub>GD</sub>	gate-drain charge	$\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \text{ V}; \ I_D = 25 \text{ A}; \\ V_{DS} = 40 \text{ V}; \ see \ \underline{Figure \ 14}; \\ see \ \underline{Figure \ 15} \end{array}$		-	21	-	nC
Static ch	aracteristics						
$R_{DSon}$	drain-source on-state resistance	$V_{GS}$ = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 25 °C;	[1]	-	3.7	4.7	mΩ

[1] Measured 3 mm from package.

# 2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	D	drain	mb	
3	S	source		
3 mb	D	mounting base; connected to drain		mbb076 S
			1 2 3 <b>SOT78</b>	

(TO-220AB;SC-46)

# 3. Ordering information

#### Table 3. Ordering information

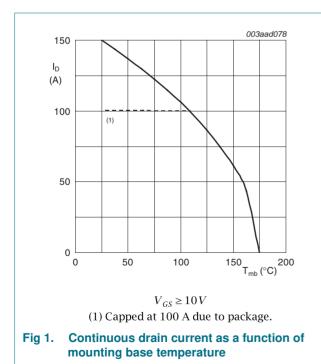
Type number	Package		
	Name	Description	Version
PSMN5R0-80PS	TO-220AB; SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

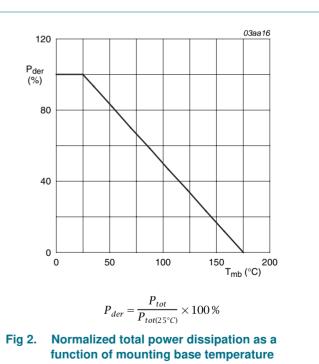
## 4. Limiting values

#### Table 4.Limiting values

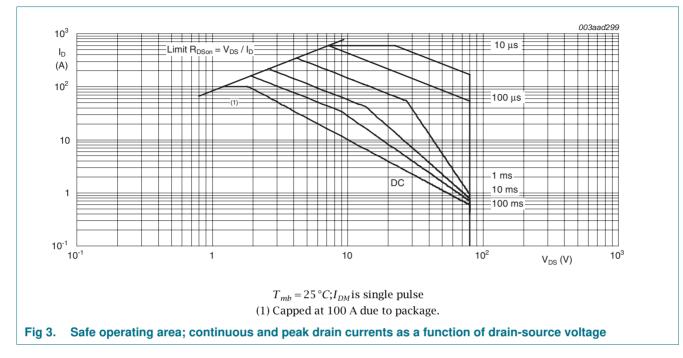
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	80	V
V <sub>DGR</sub>	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$	-	80	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	$V_{GS}$ = 10 V; $T_{mb}$ = 100 °C; see <u>Figure 1</u>	-	100	А
		$V_{GS}$ = 10 V; $T_{mb}$ = 25 °C; see <u>Figure 1</u>	-	100	А
I <sub>DM</sub>	peak drain current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$ ; see Figure 3	-	598	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	270	W
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Source-dr	ain diode				
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C	-	100	А
I <sub>SM</sub>	peak source current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$	-	598	А
Avalanche	e ruggedness				
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; $I_{D}$ = 100 A; $V_{sup}$ ≤ 80 V; $R_{GS}$ = 50 Ω; unclamped	-	396	mJ



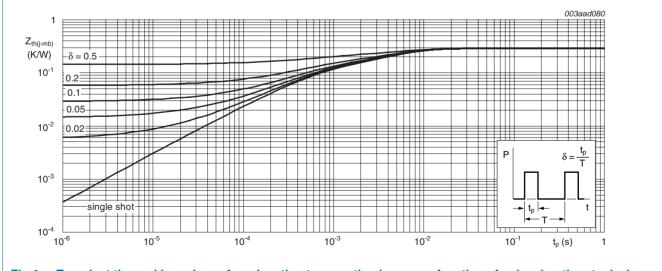


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## 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	see Figure 4	-	0.3	0.56	K/W



# Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse duration; typical values

## 6. Characteristics

Table 6.	Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	aracteristics						
V <sub>(BR)DSS</sub>	drain-source	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ\text{C}$		73	-	-	V
	breakdown voltage	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$		80	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see <u>Figure 11</u> ; see <u>Figure 12</u>		1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see <u>Figure 11</u> ; see <u>Figure 12</u>		-	-	4.6	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see Figure 11; see Figure 12		2	3	4	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	8	μA
		$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$		-	-	150	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = -20 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C		-	-	100	nA
		$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 100 °C; see <u>Figure 13</u>		-	-	7	mΩ
		$V_{GS}$ = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 25 °C	[2]	-	3.7	4.7	mΩ
R <sub>G</sub>	internal gate resistance (AC)	f = 1 MHz		-	0.95	-	Ω
Dynamic	characteristics						
Q <sub>G(tot)</sub>	total gate charge	$I_{D} = 0 \text{ A}; \text{ V}_{DS} = 0 \text{ V}; \text{ V}_{GS} = 10 \text{ V}$		-	87	-	nC
		$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$ see Figure 14; see Figure 15		-	101	-	nC
Q <sub>GS</sub>	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$		-	26	-	nC
$Q_{GS(th)}$	pre-threshold gate-source charge	see <u>Figure 14</u> ; see <u>Figure 15</u>		-	18	-	nC
$Q_{GS(th\text{-}pl)}$	post-threshold gate-source charge			-	8	-	nC
Q <sub>GD</sub>	gate-drain charge			-	21	-	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}$		-	4.2	-	V
C <sub>iss</sub>	input capacitance	$V_{DS}$ = 12 V; $V_{GS}$ = 0 V; f = 1 MHz;		-	6793	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; see <u>Figure 16</u>		-	913	-	pF
C <sub>rss</sub>	reverse transfer capacitance			-	350	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 12 V; $R_L$ = 0.5 Ω; $V_{GS}$ = 10 V;		-	33	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 4.7 \ \Omega$		-	21	-	ns
t <sub>d(off)</sub>	turn-off delay time			-	73	-	ns
t <sub>f</sub>	fall time			-	14	-	ns

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# PSMN5R0-80PS

#### N-channel 80 V 4.7 m $\Omega$ standard level MOSFET

nbol	Deveneter	Conditions			Trees	Marri	11
	Parameter	Conditions		Min	Тур	Мах	Unit
	rain diode						
)	source-drain voltage	$I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j = $ see <u>Figure 17</u>	= 25 °C;	-	0.8	1.2	V
	reverse recovery time	$I_{\rm S} = 50 \text{ A}; dI_{\rm S}/dt = 100 \text{ A}$	$\mu$ s; V <sub>GS</sub> = 0 V;	-	56	-	ns
	recovered charge	$V_{DS} = 40 V$		-	116	-	nC
	to JEDEC standards where a red 3 mm from package.	applicable.					
250 I <sub>D</sub> (A) 200 150 100 50		003aad081	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	V <sub>GS</sub> (V) = 5	50 2	003aad082 5.5 6 10 20 10 10 10 20	0
		200.06	т	$_{i} = 25 ^{\circ}C; t_{p} =$	= 300µs		
	$T_j = 25 ^{\circ}C; t_p = 3$ Output characteristics: c function of drain-source	Irain current as a	Fig 6. Drain-sourc of drain cur				unctio
f	Output characteristics: c	Irain current as a	Fig 6. Drain-sourc of drain cur				unctio
f 100	Output characteristics: c	lrain current as a voltage; typical values	Fig 6. Drain-sourc of drain curr	rent; typica	I values	•	unctio
f	Output characteristics: c	lrain current as a voltage; typical values	Fig 6. Drain-sourc of drain cur	rent; typica		•	unctio
100 I <sub>D</sub>	Output characteristics: c	lrain current as a voltage; typical values	Fig 6. Drain-source of drain current 10000 C (pF)	rent; typica	I values	•	unctio
f 100 I <sub>D</sub> (A)	Output characteristics: c	lrain current as a voltage; typical values	Fig 6. Drain-source of drain current 10000 C (pF)	rent; typica	I values	•	unctio
f 100 I <sub>D</sub> (A)	Output characteristics: c	lrain current as a voltage; typical values	Fig 6. Drain-source of drain curr (pF) 9000 8000	rent; typica	I values	•	unctio
100 I <sub>D</sub> (A) 80	Output characteristics: c	lrain current as a voltage; typical values	Fig 6. Drain-source of drain current 10000 C (pF) 9000	rent; typica	I values	•	unctio
f 100 I <sub>D</sub> (A) 80 60	Output characteristics: c	lrain current as a voltage; typical values	Fig 6. Drain-source of drain curr (pF) 9000 8000	rent; typica	Diss	•	unctio
100 I <sub>D</sub> (A) 80	Output characteristics: c	lrain current as a voltage; typical values	Fig 6. Drain-source of drain current (pF) 9000 8000 7000	rent; typica	Diss	•	unctio
f 100 I <sub>D</sub> (A) 80 60 40	Output characteristics: c	lrain current as a voltage; typical values	Fig 6. Drain-source of drain current (pF) 9000 8000 7000	rent; typica	Diss	•	unctio
f 100 I <sub>D</sub> (A) 80 60	Output characteristics: c function of drain-source	003aad083	Fig 6. Drain-source of drain current (pF) 9000 8000 7000 6000	rent; typica	Diss	•	unctio
f 100 I <sub>D</sub> (A) 80 60 40 20	Output characteristics: c function of drain-source	003aad083	Fig 6. Drain-source of drain current 100000 (pF) 90000 80000 70000 60000 50000 40000 30000	c	Diss Biss s	003aad087	
f 100 I <sub>D</sub> (A) 80 60 40 20	Output characteristics: c iunction of drain-source	003aad083	Fig 6. Drain-source of drain current (pF) 9000 8000 7000 6000 5000 4000	rent; typica	Diss	•	

### Table 6. Characteristics ... continued

PSMN5R0-80PS\_2

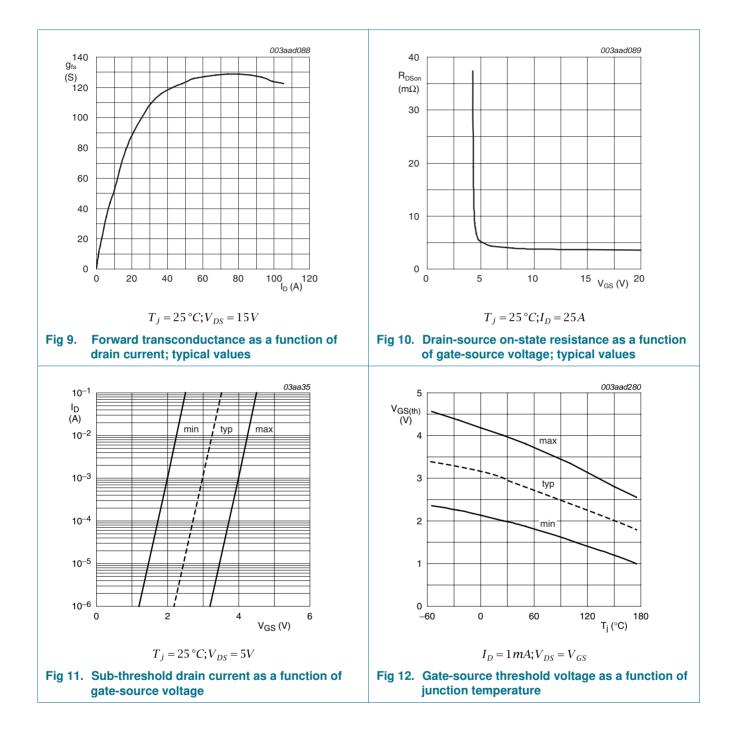
function of gate-source voltage; typical values

function of gate-source voltage; typical values

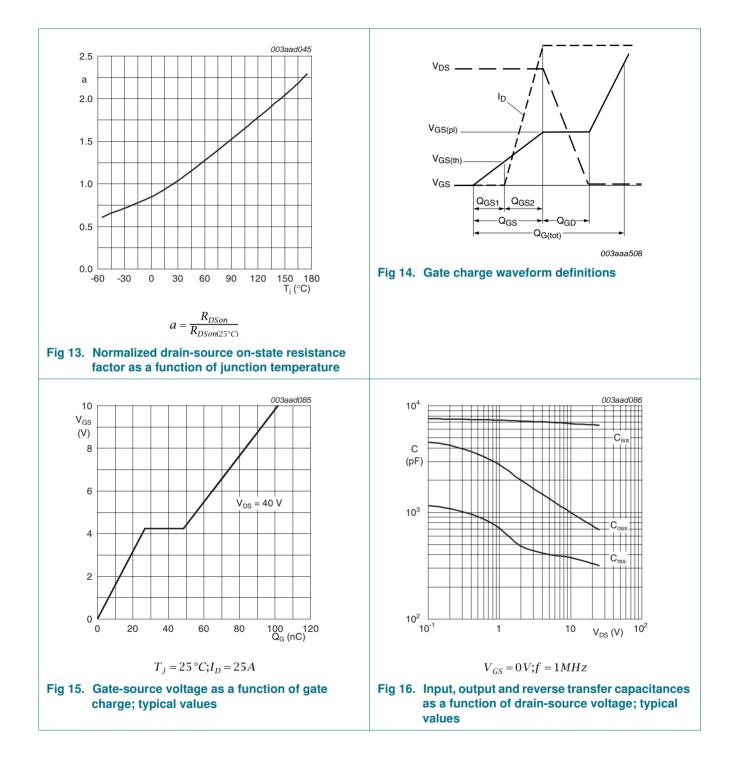
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# **PSMN5R0-80PS**

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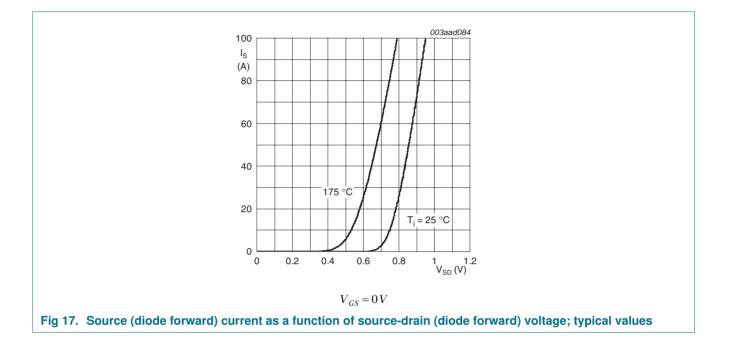
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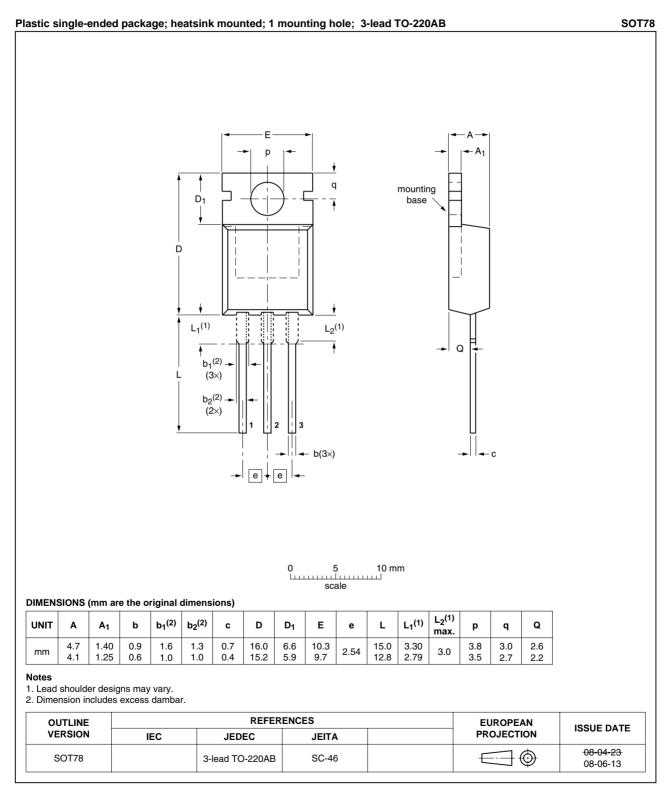
# **PSMN5R0-80PS**

#### N-channel 80 V 4.7 mΩ standard level MOSFET



#### N-channel 80 V 4.7 mΩ standard level MOSFET

## 7. Package outline



#### Fig 18. Package outline SOT78 (TO-220AB)

## 8. Revision history

#### Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN5R0-80PS_2	20090623	Product data sheet	-	PSMN5R0-80PS_1
Modifications:	<ul> <li>Status cha</li> </ul>	inged from objective to pr	oduct.	
	<ul> <li>Various ch</li> </ul>	anges to content.		
PSMN5R0-80PS_1	20090507	Objective data sheet	-	-

## 9. Legal information

### 9.1 Data sheet status

Document status [1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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